Particle aggregation on dewetting solid water films

J.S. Palmer, S. Sivaramakrishnan, P.S. Waggoner 1, J.H. Weaver * 

Department of Materials Science and Engineering, University of Illinois at Urbana-Champaign, 1304 West Green Street, Urbana, IL 61801, USA

1. Introduction

The importance of water and its elusive properties have assured that the study of condensed water remains a very active area of investigation [1]. Not surprisingly, the interaction of water with metal surfaces has been extensively investigated [2,3]. Much less is known about the inverse systems, in which metal atoms are deposited and form particles on solid water.

Recent studies have shown that nanoparticles are formed when noble metals are vapor deposited onto solid water films condensed on oxide substrates [4–6]. This use of water as a buffer extends a technique introduced by Waddill et al. [7] that is now known as buffer-layer-assisted growth or BLAG [8]. In BLAG, a gas, typically Xe, is condensed onto a cold substrate to form a buffer layer. Material deposited onto the buffer results in three-dimensional clustering as a result of the weak interaction between the buffer and the deposited material. Heating allows sublimation of the buffer and delivery of the clusters to the substrate in the ultimate of soft-landing. BLAG makes it possible to prepare a wide range of nanostructure/support systems that cannot be formed by conventional deposition. Moreover, the sizes and densities of the nanostructures produced with BLAG can be varied over more than two orders of magnitude by changing the buffer thickness and the amount of material [8,9].

In contrast to rare gas films, the structure of solid water films used for BLAG depends strongly on their deposition kinetics. Water condensed at temperatures below 110 K forms amorphous solid water (ASW), a nonequilibrium state stabilized by kinetics; condensation above ~130 K produces crystalline cubic ice (I c) [10]. Moreover, the porosity of ASW films condensed by exposure to water vapor increases significantly with decreasing condensation temperature below 90 K [11]. ASW films heated through ~135 K undergo a glass transition. The nature of water above this transition is still an issue of active debate, but isotope intermixing [12] as well as microscopy measurements [13] indicate that significant diffusion is occurring. Increasing the temperature above ~150 K results in the conversion to I c through nucleation and growth of crystallites. This restructuring could play a critical role in the aggregation of particles during BLAG with H 2O, and we have undertaken an investigation of the properties of these films.

In this paper, we demonstrate that particle assembly and aggregation on a solid water buffer layer is controlled by dewetting, islanding, and sublimation of the solid water film. Compared to noble gas buffers, there are differences both in the dewetting of the film and the interactions of the particles with the dewetting front. The interactions of particles with H 2O alter their aggregation and coalescence, and this is reflected in structures produced for Au, Cu, and Pd deposition onto ASW.

2. Experiment

The samples were grown in a chamber with a typical base pressure below 1 × 10⁻¹⁰ Torr. The substrates were 20–30-nm-thick amorphous carbon (a-C) foils supported on copper grids that were degassed in vacuo for ~24 h at 125–150 °C. The samples were fixed to copper holders that were mounted on the cold head of a closed-cycle He refrigerator to cool the samples to 20 K; the temperature was measured with a silicon diode (Lakeshore SD-470-SD) attached to the copper holder. The actual temperature at the sample...
is estimated to be within 5 K of that reported. Condensation at higher temperatures was achieved by turning off the refrigeration and allowing the cold head to slowly warm up. This results in a heating rate of 1 K/minute at 135 K. After condensation, the refrigeration system was again engaged to cool the sample to 20 K. The buffer was desorbed by removing the sample holder from the cold head with a stainless steel manipulator, which could be precooled by contact with the coldhead. Upon removal, the temperature rose to 50 K in 10 s and to 100 K in 70 s. Desorption occurred in the range of 150–170 K during which time the heating rate was 1.9 K/min.

Water was condensed by back filling the chamber to \(1 \times 10^{-6}\) Torr using a precision leak valve. The water was purified through multiple freeze and pump cycles using liquid nitrogen. The thicknesses of films grown at 20 K were determined by the exposure time and flux. The number of absorbed molecules per unit unit per unit area is:

\[ I = s \cdot \frac{p}{(2\pi mkT)^{1/2}} \]

where \(p\) is the H$_2$O partial pressure, \(m\) is the mass of a water molecule, \(T\) is the ambient temperature, \(k\) is the Boltzmann constant, and \(s\) is the sticking coefficient. The layer thicknesses are given in monolayers (ML), where 1 ML refers to the number of molecules in a (1 1 1) plane of ice. At 20 K, we assume \(s\) to be 1 so that 1 ML corresponds to 2.45 L [14]. For films condensed at higher temperatures, thicknesses were estimated by comparison of the pressure during desorption of the film with that of films condensed at lower temperatures. The pressure during desorption was monitored with an ion gauge; the maximum pressure for a 120 ML film was about \(8 \times 10^{-8}\) Torr. The area under the desorption peak of the pressure–time curve increased linearly with film thickness and provided a reliable measure of film thickness. Although desorption occurred from the sample holder and sample, differences in film thicknesses resulting from the first layer sticking coefficient are assumed to be negligible for thick films. The area under the desorption peak was also used to estimate the fraction of the buffer desorbed at different temperatures.

Metal atoms were evaporated onto the buffer layers from a tungsten basket located \(\sim 32\) cm from the samples. The thickness was determined using a calibrated quartz crystal oscillator. Samples removed from the coldhead were displaced \(\sim 2\) cm, keeping the distance from the evaporation source constant. The impinging atoms were sufficiently mobile that they could form clusters, a process favored by weak bonding with the solid buffer. The clusters aggregated when the sample was removed from the cold head to desorb the buffer.

Characterization of the samples was done at room temperature after their transfer to a Philips CM12 120-kV or JEOL 2010 LaB$_6$ 200-kV transmission electron microscope (TEM). Imaging was done in the bright-field mode, keeping the beam intensity low to avoid significant changes in morphology. The samples were stable when stored in air, and there was no evidence of coarsening.

3. Metal particles formed on solid water buffers

Contrary to expectations, the deposition of metals onto different thicknesses of H$_2$O and the subsequent buffer sublimation produces structures very similar to those formed using Xe buffers. Fig. 1 shows representative images for depositions of 5 Å of Au, 5 Å of Cu, and 3 Å of Pd on 10 and 30 ML ASW films. The 10 ML buffers result in small, high-density particles. The 30 ML buffers result in more aggregation and the formation of larger, ramified structures. As structures become larger, the time required for coalescence increases and the driving force decreases [15] such that the aggregates remain ramified even at 300 K. The shapes of the particles vary significantly, depending upon the coalescence properties of the metal. The Au particles in Fig. 1a are compact and have completely coalesced. By comparison, the Pd particles in (e), where less material was deposited, are ramified. The Cu structures show an intermediate degree of coalescence.

Fig. 2 plots the densities of particles for deposition of 5 Å of Au on ASW films that ranged in thickness from 4 to 90 ML. The solid

![Fig. 1. Morphologies produced by the deposition of 5 Å of Au, 5 Å of Cu, and 3 Å of Pd on ASW buffers of 10 and 30 nm. Particle aggregation increases with buffer thickness, and the shapes of the particles are strongly dependent upon the coalescence properties of the metals.](image1)

![Fig. 2. Particle densities following 5 Å Au depositions onto ASW buffers of different thicknesses. The solid line shows a power law fit. The dashed and dotted lines are fits from Xe and CO$_2$ buffers from Refs. [16,17].](image2)
Solid water morphology changes during heating

The morphologies of water films grown from the vapor are highly dependent on the growth conditions. Because of kinetics, ASW films condensed at 20 K are rough on a short scale, but films grown at higher temperature will have much greater variation on a longer length scale. Condensation at 20 K results in a porous, yet uniformly thick film. Water molecules condensed on a-C at 135 K are mobile and multi-layer islands are formed. These islands grow together beyond a nominal condensation of ~30 ML.

ASW films will form \( I_c \) during warming, a process controlled by the structure of the film. The nucleation and crystallization rates will determine the structure of the film, and the rate of nucleation of \( I_c \) crystals depends on the deposition technique [18] and temperature [19]. Insight into these morphological changes is important to understand the interactions of particles with these films.

To investigate the mechanism behind particle aggregation on solid water, we began by studying the morphologies of the film during sublimation. Because the particle sizes and densities are sensitive to film thickness, we can use BLAG to probe changes that occur during heating. Fig. 4a is a TEM micrograph of particles formed by depositing 1 Å of Au on 30 ML of ASW. The sample in Fig. 4b was prepared the same way except that the Au was deposited during the warm-up process when the sample reached 153 K. In the latter case, the temperature of the substrate increased ~0.5 K during the 15 s deposition. At this stage, only ~3 ML would have sublimed, as determined by the area under the pressure vs. time curve. In Fig. 4, the local densities and size distributions are indicative of the film thickness when deposition occurred. Lower density regions manifest where the residual film was thickest. The oval region surrounded by the dotted line indicates a region where all of the Au had coalesced into a single particle. Just outside the oval is a region of small, high-density particles. These particles are consistent with Au deposited directly onto a-C when there was no buffer layer, i.e., regions where dewetting had occurred prior to Au deposition at ~153 K.

The reason for this particle distribution can be understood in terms of the crystallization process. An ice crystal nucleated inside the oval and grew by accumulation of \( H_2O \) from the surrounding area. This resulted in a depleted region around the crystal. The oval marks the footprint of the crystal at 153 K. The diffusion and crystallization of ASW results in roughening of the surface; such roughening is evident in Fig. 4b by the spatial variations in size and densities. It is consistent with previous observations that significant structural changes occur during crystallization that compromises the integrity of the film [20].

As the temperature increases during sublimation, further dewetting occurs and the film breaks up into islands. Fig. 4c shows the resulting morphology for a 30 ML ASW film that was heated to 160 K. As in Fig. 4b, Au was deposited during sublimation. While only ~5 ML of \( H_2O \) had sublimed at this point, there were significant changes to the film. The dashed lines indicate regions where islands formed. Au deposited onto them led to the formation of sin-
Dewetting and sublimation occur simultaneously. Fig. 5 plots the H₂O surface coverage and its average thickness as a function of temperature. The coverages given by the squares were determined by analysis of images like those in Fig. 4. Those given by the triangles will be discussed later. The line shows the average thickness estimated from the area under the pressure vs. time curve. The formation of voids that spread and led to islanding accounts for the sudden drop in coverage at ~156 K. After the onset of dewetting, the coverage decreases more gradually at ~160 K, indicating that islanding is complete and further reduction can be attributed to sublimation. Once formed, the islands can break apart during sublimation, as seen by those that resulted in two particles in Fig. 4c. Note that the coverage drops to zero before all the water has desorbed; this is an artifact of our technique not having enough resolution to observe a few monolayers of H₂O.²

Although influenced by crystallization and the glass transition, dewetting is not dependent solely upon them. We have also observed thermally activated dewetting of thin crystalline ice films on a-C due to grooving at grain boundaries that leads to void formation. Fig. 6 shows the results of depositing 1 Å of Au on a 57 ML ice film condensed at 140 K. After condensation, the film was cooled to 20 K and then warmed, as with the other samples. This growth sequence eliminated effects related to crystallization or the glass transition. The particle size distribution indicates that ice films dewet, with islanding in Fig. 6 at a stage between those shown in Fig. 4b and c. The dotted lines indicate the boundaries between the exposed substrate and the ice islands, as in Fig. 4c.

5. Particle aggregation on a dewetting film

Recent observations of Au particles on Xe indicate that capillary forces are responsible for aggregation during solid state dewetting and sublimation of the buffer [23]. The results of this study indicate a similar process for particle aggregation on H₂O. This is in contrast to earlier models for cluster aggregation during BLAG that assumed an ideal surface on which clusters could diffuse [16], with the grain structure and grooving introducing only slight perturbations [24]. These results are closer to the model proposed by Yan et al. [5] for Ag cluster formation on a ~3 ML ice layer that involved the formation of liquid droplets that swept along the Ag clusters and led to aggregation during desorption, but we have no indication of a liquid phase at 150 K.

To investigate the interaction of particles with dewetting ASW, we performed two-step evaporation sequences. First, we deposited 4 Å of Au on a 30 ML ASW film at 20 K and removed the sample from the cold head, as in our typical BLAG experiments. When the temperature reached 155 K, we deposited another 1 Å of Au and allowed the film to continue to sublime. Fig. 7a shows the result. The marked regions indicate that water had dewet so that the Au from the second evaporation formed small clusters on the exposed a-C substrate. Significantly, those particles formed during the initial 4 Å deposition retreated with the dewetting film. As for Au on Xe, it is reasonable to assume that the clusters sink partially into the solid water film to reduce surface energy. As the film dewets through molecular diffusion and H₂O overgrows the

---

² The resolution for determining the dewet/covered areas of the surface is limited by the spacing between particles deposited on the a-C, namely ~5 nm. The dewetting front continues to move as the Au is deposited. As the layers become thinner, it is difficult to distinguish particles deposited on a-C from those deposited onto H₂O. It is also not possible to determine how much water coats a particle.
particles, capillary forces move the particles with the dewetting front. Particles are initially concentrated along the front, but they aggregate as the solid water islands shrink due to sublimation. Accordingly, their sizes, shapes, and densities are related to the sizes, shapes, and densities of the islands.

In a second set of experiments, we prepared samples as for Fig. 7a except that the final 1 Å was deposited at 163 K, allowing the film to have exposed more of the a-C substrate. Fig. 7b shows that all of the initial 4 Å of Au has been concentrated into extended particles. This demonstrates the relationship between the island size and shape (dotted lines) and the final particle size and shape within the areas covered by solid water.

Comparison of Fig. 7b with Fig. 4c suggests that Au deposited on the ASW film affects dewetting, with the 4 Å of Au deposited at 20 K inhibiting dewetting. Dewetting is governed by the molecular diffusion of water. The triangles in Fig. 5 indicate coverages for samples prepared like those in Fig. 7, with the final 1 Å deposited at higher temperatures. The difference between the triangles and squares demonstrates that the particles slow down diffusion and dewetting. However, when sublimation is taken into account, inhibiting the diffusion leads to a thinner film, a decrease in the island size, and an increase in the island density.

Different nanoparticles will have different impacts on H₂O diffusion, reflecting their interactions with water. Table 1 lists the power law decay exponents for the densities and the percent surface coverage for Au, Cu, and Pd particles along with the interaction of water with their (111) and (110) surfaces. The table indicates the increase in the maximum desorption temperature for one monolayer compared to the multilayer desorption peak. Higher temperatures indicate a stronger interaction. The stronger interaction is manifest both in the variation in particle densities and particle surface coverage. A stronger interaction leads to a steeper power law decay because H₂O diffusion is inhibited, slowing void nucleation and growth. The coverage measures how much coalescence has occurred. Increased coalescence results in lower surface coverage. Particles can become coated with a layer of H₂O, which will inhibit coalescence and result in more ramified structures. The impact of the water–metal interaction is evident in Fig. 1.

The interaction of the particles with the buffer varies significantly with the buffer material. The similarities among the densities of Au on Xe, CO₂, and H₂O shown in Fig. 2 suggest a scaling behavior between the particle–buffer interaction and the desorption temperature of the buffer. The scaling of the interaction energy with the cohesive energy of the buffer results in similar particle sizes and densities for a wide range of desorption temperatures and interaction energies.

### 6. Comparison of solid water to Xe

Comparison of the metal structures produced on H₂O films with those produced on Xe suggests that the particle aggregation processes are very similar. Both are driven by the dewetting of the film, but the particle interactions with the dewetting front show some key differences. Dewetting in Xe films leads to fingering [23] in a manner similar to the islanding of metal films [25]. These fingers eventually pinch off, and the process continues. A consequence is that particles are left behind the dewetting front. The equivalent is not observed on H₂O films, since no particles were left behind in the dewet regions in Fig. 6 and all the Au was concentrated onto the water islands.

Two features could contribute to the prevention of fingering of H₂O films. One, the stronger surface tension of water prevents fingering from occurring. This would keep Au particles moving with the front, allowing them to form larger structures than those observed on Xe. Second, the ASW films develop a much higher density of voids. The higher the void density, the shorter the distance the dewetting fronts must travel during islanding and the less chance there is for formation. Particle sizes from Xe and ASW films are similar, while the void density is significantly higher for ASW than Xe films (∼6 × 10⁸ for 5 Å of Au on a 20 ML Xe film and ∼4 × 10⁸ for 4 Å of Au on 30 ML ASW). This indicates that the void formation is more important than the change in surface tension. The ASW films break up into much smaller islands than the Xe films made up of low energy grains. This structural difference inhibits fingering of ASW films. Even with this difference, the resulting structures produced on Xe and ASW films are very similar.

### 7. Conclusions

We have demonstrated that metals deposited on thin ASW films on a-C form particles that aggregate during dewetting and islanding. Dewetting is observed by depositing Au during heating. Deposition onto continuous films results in a homogeneous size distributions, while deposition onto dewet films results in an inhomogeneous size distribution. Dewetting occurs regardless of whether the film is amorphous or crystalline, although the mechanisms involved in void nucleation may change. Because aggregation occurs during dewetting near the sublimation temperature, deposition onto structurally different porous ASW and crystalline ice results in similar particles. The sizes of the dewetting islands affect the sizes and shapes of the resulting particles, and the metal interaction with the water affects the dewetting and the aggregation/coalescence of the structures. This dewetting-driven process is similar to that observed on Xe films, and we expect it to be a general process with small particles on thin volatile films since complete wetting of condensed gasses on surfaces is a rare occurrence [32]. In particular, recent observations indicate that ASW also dewets Pt(111) [33], Pd(111) [33], and Ru(0001) [34] during crystallization, leaving a monolayer, while Ni(111) provides a counter example where dewetting does not occur [35].

### Acknowledgments

Early stages of this work were supported by the US Department of Energy, Division of Materials Sciences under Grant No. DEFG02-01ER45944. TEM imaging was carried out in the Center for Microanalysis of Materials, University of Illinois, which is partially supported by the US Department of Energy under Grant DEFG02-91ER45439. We thank P. Swaminathan for stimulating discussions.

### References


### Table 1

Comparison of the aggregation/coalescence tendencies of Au, Cu, and Pd to the desorption properties of H₂O on those metals.

<table>
<thead>
<tr>
<th>Material</th>
<th>Power law exponent</th>
<th>% Surface coverage</th>
<th>Desorption peak shift (K)</th>
</tr>
</thead>
<tbody>
<tr>
<td>5 Å Au</td>
<td>2.01</td>
<td>7.3</td>
<td>0 (Ref. [26])</td>
</tr>
<tr>
<td>5 Å Cu</td>
<td>2.17</td>
<td>9.4</td>
<td>0 (Ref. [28])</td>
</tr>
<tr>
<td>3 Å Pd</td>
<td>2.70</td>
<td>12.7</td>
<td>15 (Ref. [30])</td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td>10 (Ref. [29])</td>
</tr>
</tbody>
</table>

The desorption peak shift refers to the temperature of the final ML desorption peak with reference to the 150 K multilayer peak for single crystal surface. The surface coverage is averaged for particles produced on solid water films of 60 ML and greater.